#### **TOSHIBA LED Lamp**

# TLWD1060(T18)

#### Panel Circuit Indicator

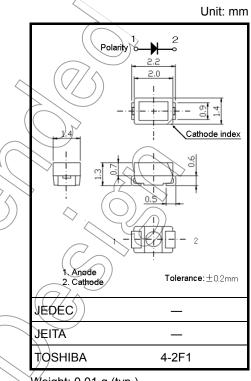
- Surface-mount devices
- $2.2 \text{ (L)} \times 1.4 \text{ (W)} \times 1.3 \text{ (H)} \text{ mm}$
- LED chip + phosphor
- Color: White Cx = 0.31 (typ), Cy = 0.30(typ), 90mcd(typ.) @10mA
- Low drive current, high-intensity light emission
- Topr / Tstg = -40 to 100°C
- Applications: backlighting, pilot lamp etc.
- Standard embossed tape packing: T18 (3000 pcs / reel)

8-mm tape reel

#### Color and Material

Product Name	Color	Material
TLWD1060	White	InGaN

# Absolute Maximum Ratings (Ta = 25°C)



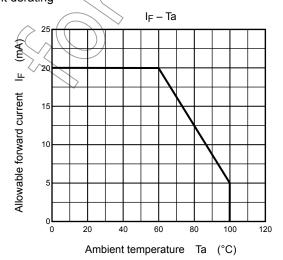
Weight: 0.01 g (typ.)

		/ ~ ^			
Product Name	Forward Current I <sub>F</sub> (mA) Please see Note 1	Reverse Voltage V <sub>R</sub> (V)	Power Dissipation	Operation Temperature T <sub>opr</sub> (°C)	Storage Temperature T <sub>stg</sub> (°C)
TLWD1060	20 (//	)) 4	76	-40 to 100	-40 to 100

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Forward current derating



# **Electrical Characteristics (Ta = 25°C)**

Product Name	Forward Voltage V <sub>F</sub>			Reverse Current IR		
Froduct Name	Min	Тур.	Max	l <sub>F</sub>	Max	$V_{R}$
TLWD1060	2.5	3.0	3.8	10	10	4
Unit	V			mA	μА	V

Optical Characteristics (Ta = 25°C)

Item	Symbol	Test condition	Min.	Тур.	Max.	Unit
Chromaticity coordinate	C <sub>x</sub>	I <sub>F</sub> = 10 mA		(Note 2)		_
Chromaticity coordinate	Су	I <sub>F</sub> = 10 mA	>	(Note 2)		_
Luminous intensity	ly	I <sub>F</sub> = 10 mA (Note 3)	40	90	200	mcd

Note 2: The product is tested at the following chromaticity coordinate groups.

Test conditions: I<sub>F</sub>=10mA, Ta=25°C

Accuracy: +/-0.01

0.42
0.41
0.40
0.39
0.38
0.37
0.36
0.35
0.34
0.33
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	Cx	Cy /		Сх	Су		Сх	Су
	0.273	0.227	(	0.296	0.259		0.330	0.310
3K	0.266	0.232	5K	0.291	0.268	7K	0.330	0.330
) <b>3</b> 1	0.280	0.252	300	0.310	0.297	/ / /	0.338	0.342
	0.286	0.244		0.313	0.284		0.352	0.344
	0.266	0.232		0.291	0.268		0.330	0.330
3L	0.258	0.239	5L	0.285	0.279	7L	0.330	0.347
JL	0.273	0.261	JL	0.307	0.312		0.347	0.371
	0.280	0.252		0.310	0.297		0.345	0.352
	0.286	0.244		0.313	0.284	8K	0.352	0.344
4K	0.280	0.252	6K	0.310	0.297		0.338	0.342
711	0.291	0.268	UK.	0.330	0.330		0.364	0.380
	0.296	0.259		0.330	0.310		0.360	0.357
	0.280	0.252		0.310	0.297		0.345	0.352
4L	0.273	0.261	6L	0.307	0.312	8L	0.347	0.371
76	0.285	0.279		0.330	0.347	OL	0.367	0.401
	0.291 0.268		0.330	0.330		0.364	0.380	

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Note 3: Luminous Intensity classification

	@Ta=25°C					
ıs	Intensity I	V				
	Max	lF				
	200					
	90					

	Product name		Luminous Intensity I <sub>V</sub>				
			Min	Тур.	Max	lF	
	TLWD106	0(T18)	40	_	200		
		PA	40	_	80	10	
		QA	63	_	125	10	
		RA	100	_	200		
	Unit			mcd		mA	

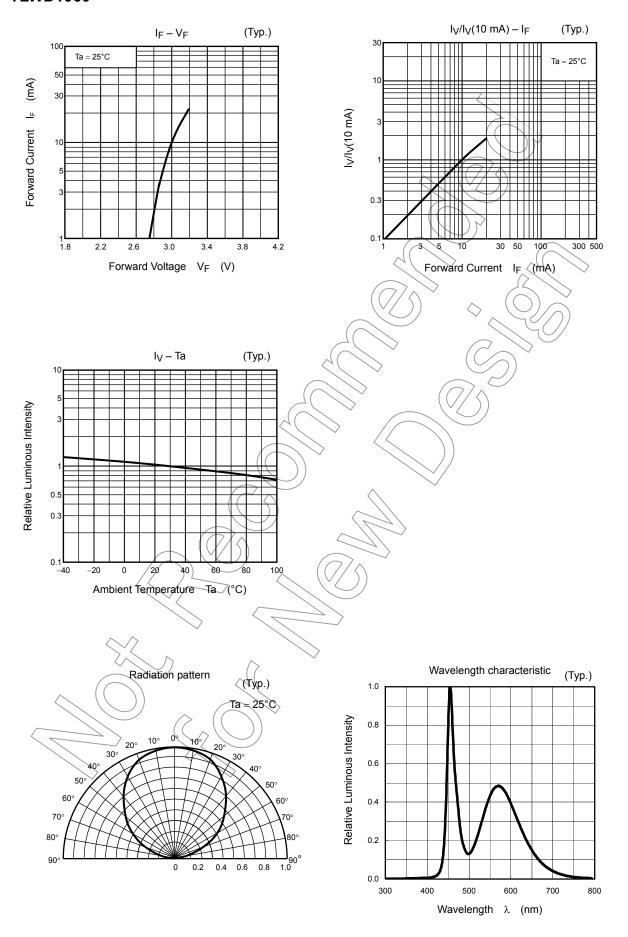
The specification on the above table is used for Iv classification of LEDs in Toshiba facility. Each reel includes the same rank LEDs. Let the delivery ratio of each rank be unquestioned.

#### The cautions

- ESD withstand voltage according to MIL STD 883D, Method 3015.7 ( ≥1000V
- When handling this LED, take the following measures to prevent the LED from being damaged or otherwise adversely affected.
  - 1) Use a conductive tablemat and conductive floor mat, and ground the workbench and floor.
  - 2) Operators handling laser diodes must be grounded via a high resistance (about 1M\O). A conductive strap is good for this purpose.
  - 3) Ground all tools including soldering irons.
- This product is designed as a general display light, source usage, and it has applied the measurement standard that matched with the sensitivity of human's eyes. Therefore, it is not intended for usage of functional application (ex. Light source for sensor, optical communication and etc) except general display light source.



## **TLWD1060**



## **Packaging**

These LED devices are packed in an aluminum envelope with a silica gel and a moisture indicator to avoid moisture absorption. The optical characteristics of the devices may be affected by exposure to moisture in the air before soldering and they should therefore be stored under the following conditions:

1. This moisture proof bag may be stored unopened within 12 months at the following conditions.

Temperature: 5°C~30°C Humidity: 90% (max)

- 2. After opening the moisture proof bag, the devices should be assembled within 168 hours in an environment of 5°C to 30°C/60% RH or below.
- 3. If upon opening, the moisture indicator card shows humidity 30% or above (Color of indication changes to pink) or the expiration date has passed, the devices should be baked in taping with reel.

  After baking, use the baked devices within 72 hours, but perform baking only once.

Baking conditions: 60±5°C, for 12 to 24 hours.

Expiration date: 12 months from sealing date, which is imprinted on the label.

- 4. Repeated baking can cause the peeling strength of the taping to change, then leads to trouble in mounting. Furthermore, prevent the devices from being destructed against static electricity for baking of it.
- 5. If the packing material of laminate would be broken, the hermeticity would deteriorate. Therefore do not throw or drop the packed devices.

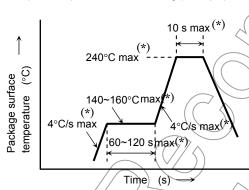
# **Mounting Method**

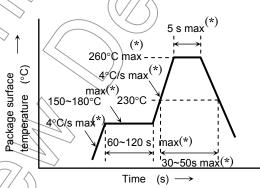
## Soldering

· Reflow soldering

Temperature profile for Pb soldering (example)

Temperature profile for Pb-free soldering (example)





• The products are evaluated using above reflow soldering conditions. No additional test is performed exceed the condition (i.e. the condition more than (\*)MAX values) as a evaluation. Please perform reflow soldering under the above conditions.

• Please perform the first reflow soldering with reference to the above temperature profile and within 168 h of opening the package.

· Second reflow soldering

In case of second reflow soldering should be performed within 168 h of the first reflow under the above conditions.

Storage conditions before the second reflow soldering: 30°C, 60% RH (max)

Make any necessary soldering corrections manually.

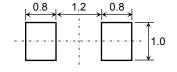
(only once at each soldering point)

Soldering iron: 25 W
Temperature: 300°C or less
Time: within 3 s

· Do not perform wave soldering.

#### Land pattern dimensions for reference only

Unit: mm



#### Cleaning

When cleaning is required after soldering, Toshiba recommends the following cleaning solvents. It is confirmed that these solvents have no effect on semiconductor devices in our dipping test (under the recommended conditions). In selecting the one for your actual usage, please perform sufficient review on washing condition, using condition and etc.

ASAHI CLEAN AK-225AES : (made by ASAHI GLASS)

KAO CLEAN THROUGH 750H : (made by KAO)

PINE ALPHA ST-100S : (made by ARAKAWA CHEMICAI

## **Precautions when Mounting**

Do not apply force to the plastic part of the LED under high-temperature conditions.

To avoid damaging the LED plastic, do not apply friction using a hard material.

When installing the PCB in a product, ensure that the device does not come into contact with other emponents.

# **Tape Specifications**

#### 1. Product number format

The type of package used for shipment is denoted by a symbol suffix after the product number. The method of classification is as below. (this method, however does not apply to products whose electrical characteristics differ from standard Toshiba specifications)

- (1) Tape Type: T18 (4-mm pitch)
- (2) Example

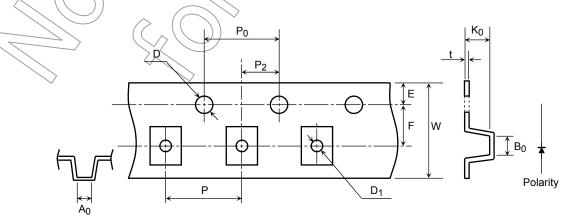
TLWD1060 (T18)
Tape type
Toshiba product No.

## 2. Tape dimensions

Unit: mm

Symbol	Dimension	Tolerance
D	//1.5 )	+0.1/-0
Е	1.75	±0.1
P <sub>0</sub>	4.0	±0.1
t 🚫		±0.05
F 🗸	3,5	±0.05
D <sub>1</sub>	1.1	±0.1

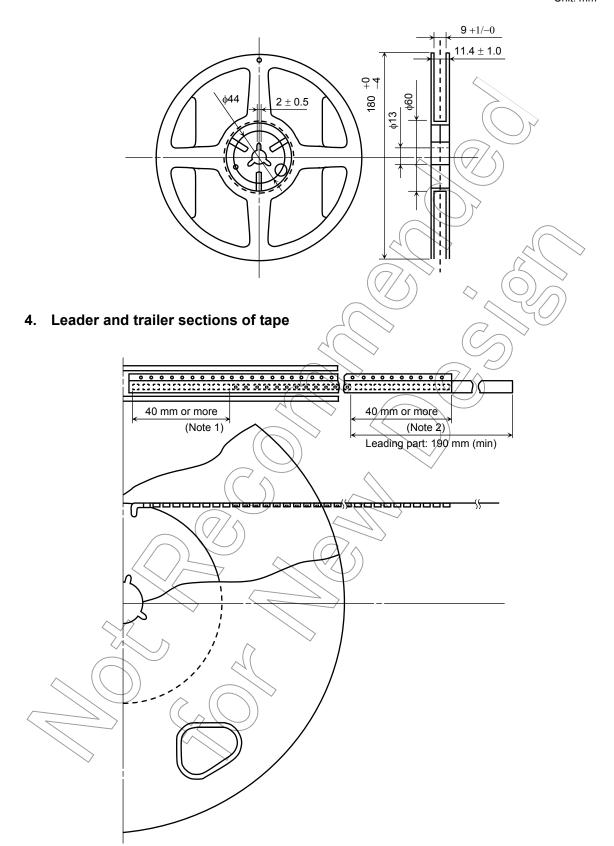
Symbol	Dimension	Tolerance
(P <sub>2</sub> / /)	2.0	±0.05
M	8.0	±0.2
P	4.0	±0.1
A <sub>0</sub>	1.5	±0.1
→ B <sub>0</sub>	2.5	±0.1
K <sub>0</sub>	1.5	±0.1



### 3. Reel dimensions

**TOSHIBA** 

Unit: mm



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Note1: Empty trailer section

Note2: Empty leader section

## 5. Packing display

(1) Packing quantity

Reel	3,000 pcs
Carton	15,000 pcs

(2) Packing form: Each reel is sealed in an aluminum pack with silica gel.

#### 6. Label format

(1) Example: TLWD1060 (T18)

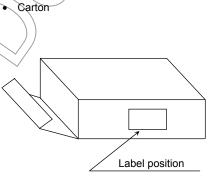
P/N: **TLWD1060** TYPE Q'TY 3,000 pcs ADDC (T18)Lot Number Key code for TSB (RANK SYMBOL) 32C 3000

Use under 5-30degC/60%RH within 168h

SEALED DIFFUSED IN \*\*\*\* ASSEMBLED IN \*\* [[G]]/RoHS COMPATIBLE

(2) Label location

Reel



Label position

The aluminum package in which the reel is supplied also has the label attached to center of one side.

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Tape feel direction

2012-02-02

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